CAN Bus Protector, Dual Line

NUP3125, SZNUP3125

The SZ/NUP3125 has been designed to protect the CAN transceiver in 24 V designs from ESD and other harmful surge protection events. This device provides bidirectional protection for each data line with a single compact SC−70 (SOT−323) package, giving the system designer a low cost option for improving system reliability and meeting stringent EMI requirements.

Features

- 120 W Peak Power Dissipation per Line (8/20 μs Waveform)
- Diode Capacitance Matching
- Low Reverse Leakage Current (< 100 nA)
- IEC Compatibility: – IEC 61000−4−2 (ESD): Level 4
  – IEC 61000−4−4 (EFT): 50 A – 5/50 ns
  – IEC 61000−4−5 (Lighting) 2.0 A (8/20 μs)
- Flammability Rating UL 94 V−0
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC−Q101 Qualified and PPAP Capable
- These Devices are Pb−Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Automotive Networks
  - CAN / CAN−FD
  - Low and High−Speed CAN
  - Fault Tolerant CAN
  - Trucks
- Industrial Control Networks
  - Smart Distribution Systems (SDS)
  - DeviceNet

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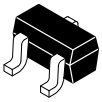
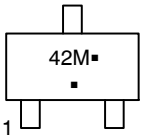
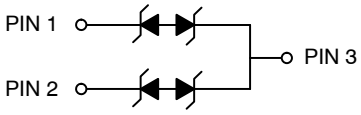
MARKING DIAGRAM

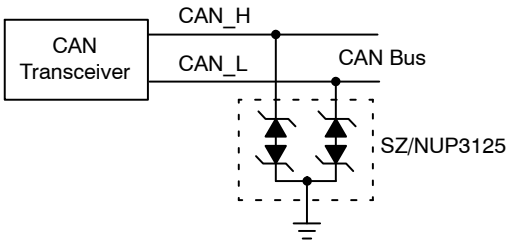


SC−70
CASE 419



42 = Specific Device Code
M = Date Code
▪ = Pb−Free Package
(Note: Microdot may be in either location)





ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

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MAXIMUM RATINGS (T_J = 25°C, unless otherwise specified)

Symbol	Rating	Value	Unit
P_{PK}	Peak Power Dissipation, 8/20 μs Double Exponential Waveform (Note 1)	120	W
T_J	Operating Junction Temperature Range	−55 to 150	°C
T_J	Storage Temperature Range	−55 to 150	°C
T_L	Lead Solder Temperature (10 s)	260	°C
ESD	Human Body Model (HBM) Machine Model (MM) IEC 61000−4−2 (Contact) IEC 61000−4−2 (Air)	8.0 1.6 21 21	kV

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Non−repetitive current pulse per Figure 1.

ELECTRICAL CHARACTERISTICS (T_J = 25°C, unless otherwise specified)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V_{RWM}	Reverse Working Voltage	(Note 2)	–	–	32	V
V_{BR}	Breakdown Voltage	I_T = 1 mA (Note 3)	35.6	39	–	V
I_R	Reverse Leakage Current	V_{RWM} = 32 V	–	–	100	nA
V_C	Clamping Voltage	8/20 μs Waveform (Note 4) I_{PP} = 1 A I_{PP} = 2 A	 – –	 47 57	 55 60	V
I_{PP}	Maximum Peak Pulse Current	8/20 μs Waveform (Note 4)	–	–	2.0	A
C_J	Capacitance	V_R = 0 V, f = 1 MHz (Line to GND)	–	5.7	10	pF
		V_R = 5 V, f = 1 MHz (Line to GND)	–	4.5	6.0	pF
		V_R = 5 V, f = 1 MHz (Line to GND), T_J = 150°C	–	5.0		pF
ΔC	Diode Capacitance Matching	V_R = 0 V, 5 MHz (Note 5)	–	0.26	2	%

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Surge protection devices are normally selected according to the working peak reverse voltage (V_{RWM}), which should be equal or greater than the DC or continuous peak operating voltage level.
3. V_{BR} is measured at pulse test current I_T.
4. Pulse waveform per Figure 1.
5. ΔC is the percentage difference between C_J of lines 1 and 2 measured according to the test conditions given in the electrical characteristics table.

ORDERING INFORMATION

Device	Package	Shipping†
NUP3125WTT1G	SC−70 (Pb−Free)	3000 / Tape & Reel
SZNUP3125WTT1G	SC−70 (Pb−Free)	3000 / Tape & Reel
NUP3125WTT3G	SC−70 (Pb−Free)	10000 / Tape & Reel
SZNUP3125WTT3G	SC−70 (Pb−Free)	10000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

TYPICAL PERFORMANCE CURVES

(T_J = 25°C unless otherwise noted)

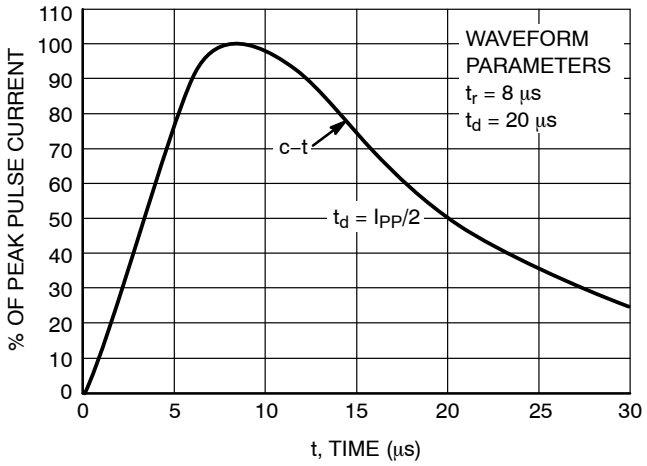


Figure 1. Pulse Waveform, 8/20 μs

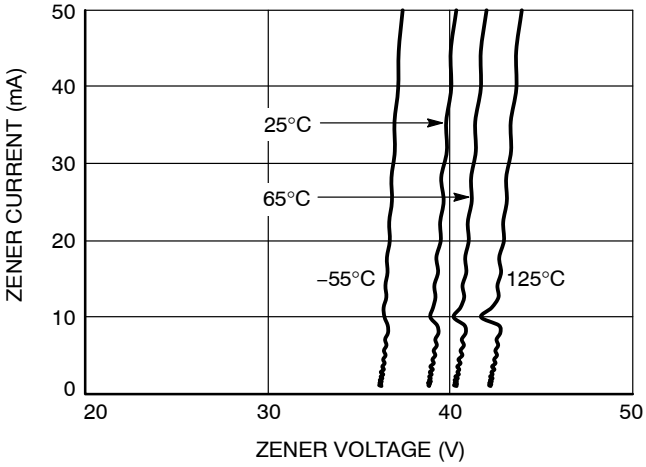


Figure 2. IV Characteristics

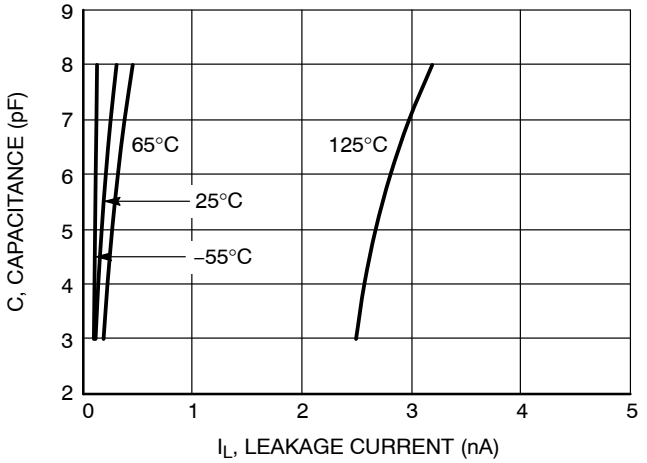


Figure 3. IR vs Temperature Characteristics

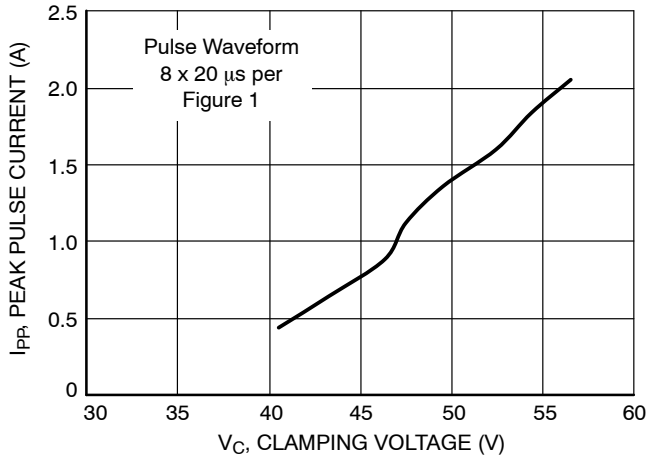


Figure 4. Clamping Voltage vs. Peak Pulse Current

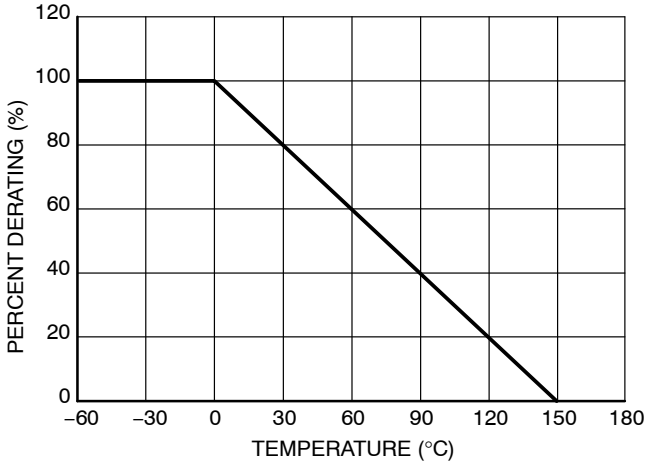


Figure 5. Temperature Power Dissipation Derating

Surge Protection Diode Circuit

Surge protection diodes provide protection to a transceiver by clamping a surge voltage to a safe level. Surge protection diodes have high impedance below and low impedance above their breakdown voltage. A surge protection Zener diode has its junction optimized to absorb the high peak energy of a transient event, while a standard Zener diode is designed and specified to clamp a steady state voltage.

Figure 6 provides an example of a dual bidirectional surge protection diode array that can be used for protection with the high−speed CAN network. The bidirectional array is created from four identical Zener TVS diodes. The clamping voltage of the composite device is equal to the breakdown voltage of the diode that is reversed biased, plus the diode drop of the second diode that is forwarded biased.

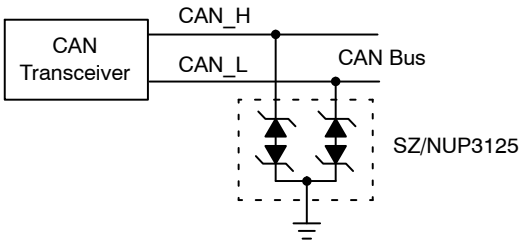
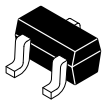


Figure 6. High−Speed and Fault Tolerant CAN Surge Protection Circuit

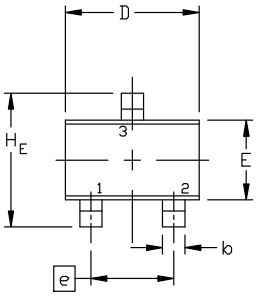
MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

SC−70 (SOT−323)
CASE 419
ISSUE R

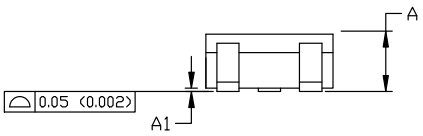
DATE 11 OCT 2022



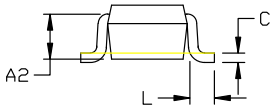
SCALE 4:1



TOP VIEW



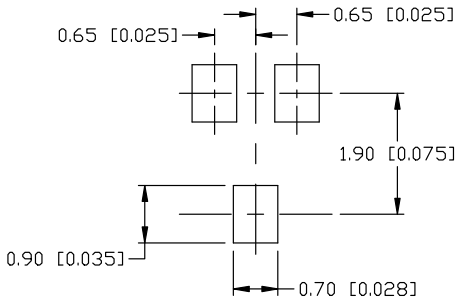
SIDE VIEW



END VIEW

NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH

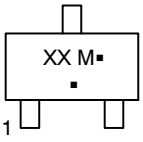
	MILLIMETERS			INCHES		
DIM	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.80	0.90	1.00	0.032	0.035	0.040
A1	0.00	0.05	0.10	0.000	0.002	0.004
A2	0.70 REF			0.028 BSC		
b	0.30	0.35	0.40	0.012	0.014	0.016
c	0.10	0.18	0.25	0.004	0.007	0.010
D	1.80	2.00	2.20	0.071	0.080	0.087
E	1.15	1.24	1.35	0.045	0.049	0.053
e	1.20	1.30	1.40	0.047	0.051	0.055
e1	0.65 BSC			0.026 BSC		
L	0.20	0.38	0.56	0.008	0.015	0.022
H_E	2.00	2.10	2.40	0.079	0.083	0.095



* For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

SOLDERING FOOTPRINT

GENERIC MARKING DIAGRAM



XX = Specific Device Code
M = Date Code
▪ = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “▪”, may or may not be present. Some products may not follow the Generic Marking.

STYLE 1:
CANCELLED

STYLE 2:
PIN 1. ANODE
2. N.C.
3. CATHODE

STYLE 3:
PIN 1. BASE
2. EMITTER
3. COLLECTOR

STYLE 4:
PIN 1. CATHODE
2. CATHODE
3. ANODE

STYLE 5:
PIN 1. ANODE
2. ANODE
3. CATHODE

STYLE 6:
PIN 1. EMITTER
2. BASE
3. COLLECTOR

STYLE 7:
PIN 1. BASE
2. EMITTER
3. COLLECTOR

STYLE 8:
PIN 1. GATE
2. SOURCE
3. DRAIN

STYLE 9:
PIN 1. ANODE
2. CATHODE
3. CATHODE−ANODE

STYLE 10:
PIN 1. CATHODE
2. ANODE
3. ANODE−CATHODE

STYLE 11:
PIN 1. CATHODE
2. CATHODE
3. CATHODE

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